DISCRETE SEMICONDUCTORS

DATA SHEET

BUJ100Silicon Diffused Power Transistor

Product specification

September 2018



Silicon Diffused Power Transistor

BUJ100

GENERAL DESCRIPTION

High-voltage, high-speed planar-passivated npn power switching transistor in the TO92 envelope intended for use in compact fluorescent lamps and low power electronic lighting ballasts, converters and inverters, etc.

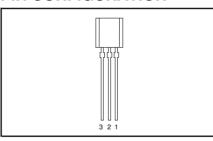
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _{CESM}	Collector-emitter voltage peak value	$V_{RF} = 0 \text{ V}$	-	700	V
V _{CBO}	Collector-Base voltage (open emitter)		-	700	l v l
V _{CEO}	Collector-emitter voltage (open base)		-	400	V
I _C	Collector current (DC)		-	1.0	Α
1 1	Collector current peak value		-	2.0	Α
P _{tot}	Total power dissipation	$T_{lead} \le 25 ^{\circ}C$	-	2	W
V _{CEsat}	Collector-emitter saturation voltage	$I_{lead} \le 25 ^{\circ}C$ $I_{C} = 0.75 A; I_{B} = 150 \text{mA}$	0.24	1.0	V
h _{FE}	, and the second	$I_{\rm C} = 0.75 \text{A}; V_{\rm CE} = 5 \text{V}$	14	20	
l t _{fi}	Fall time (Inductive)	$I_{\rm C} = 1.0 \text{ A}; I_{\rm BON} = 200 \text{mA}$	50	70	ns

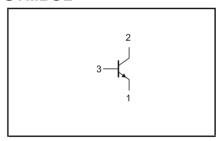
PINNING - TO92

PIN	DESCRIPTION	
1	Emitter	
2	Collector	
3	Base	

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CESM}	Collector to emitter voltage	$V_{BE} = 0 \text{ V}$	-	700	V
V _{CESM}	Collector to emitter voltage (open base)		-	400	V
V _{CBO}	Collector to base voltage (open emitter)		-	700	V
I _c	Collector current (DC)		-	1.0	Α
I _{CM}	Collector current peak value		-	2.0	Α
I _B	Base current (DC)		-	0.5	Α
I _{BM}	Base current peak value		-	1.0	Α
P _{tot}	Total power dissipation	T _{lead} ≤ 25 °C	-	2	W
T _{stq}	Storage temperature		-65	150	°C
T _i	Junction temperature		-	150	°C

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
R _{th j-lead}	Thermal resistance junction to lead		1	60	K/W
R _{th j-a}	Thermal resistance Junction to ambient	pcb mounted; lead length = 4mm	150	-	K/W

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STATIC CHARACTERISTICS

 $T_{lead} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CES} ,I _{CBO}	Collector cut-off current 1	$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}$ $V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax};$ $T_i = 125 \text{ °C}$		0.8 2.0	100 500	μ Α μ Α
I _{CEO} I _{EBO} V _{CEOsust}	Collector cut-off current Emitter cut-off current Collector-emitter sustaining voltage	$V_{CEO} = V_{CEOMmax}(400V)$ $V_{EB} = 9 \text{ V}; I_{C} = 0 \text{ A}$ $I_{B} = 0 \text{ A}; I_{C} = 10\text{mA};$ $I_{C} = 25 \text{ mH}$	- - 400	- 0.05 -	100 100 -	μΑ μΑ V
V _{CEsat} V _{BEsat}	Collector-emitter saturation voltage Base-emitter saturation voltage	$I_{C} = 0.75 \text{ A}; I_{B} = 0.15 \text{ A}$ $I_{C} = 0.75 \text{ A}; I_{B} = 0.15 \text{ A}$	- -	0.24 0.93	1.0 1.3	V V
h _{FE} h _{FE} h _{FE}	DC current gain	$\begin{array}{l} I_{C} = 10 \text{mA}; V_{CE} = 5 V \\ I_{C} = 100 \text{mA}; V_{CE} = 5 V \\ I_{C} = 0.75 A; V_{CE} = 5 V \end{array}$	11 12.5 9	20 21 14	27 31 20	

DYNAMIC CHARACTERISTICS

 $T_{lead} = 25$ °C unless otherwise specified

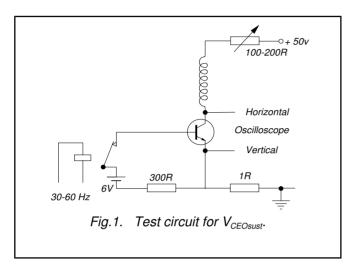
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
	Switching times (resistive load)	$I_{Con} = 1.0 \text{ A}; I_{Bon} = -I_{Boff} = 200 \text{mA}; R_L = 75 \text{ ohms}; V_{BB2} = 4 \text{ V};$			
ton ts tf	Turn-on time Turn-off storage time Turn-off fall time		0.65 0.88 250	0.88 1.2 338	μs μs ns
	Switching times (inductive load)	$I_{Con} = 1.0 \text{ A}; I_{Bon} = 200 \text{mA}; L_{B} = 1 \mu\text{H}; \\ -V_{BB} = 5 \text{ V}$			
t _s t _f	Turn-off storage time Turn-off fall time	ABB — 2 A	0.51 50	0.7 70	μs ns
	Switching times (inductive load)	$I_{Con} = 1.0 \text{ A}; I_{Bon} = 200 \text{mA}; L_{B} = 1 \mu\text{H}; \\ -V_{BB} = 5 \text{ V}; T_{i} = 100 ^{\circ}\text{C}$			
t _s t _f	Turn-off storage time Turn-off fall time	VBB - 5 V, 1, - 155 C	- -	1.4 130	μs ns

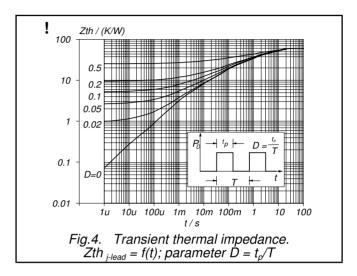
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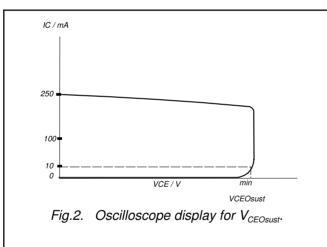
¹ Measured with half sine-wave voltage (curve tracer).

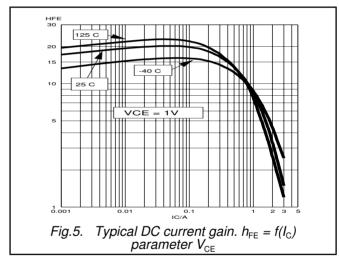
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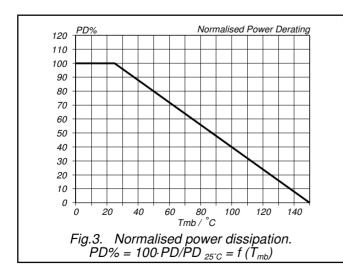
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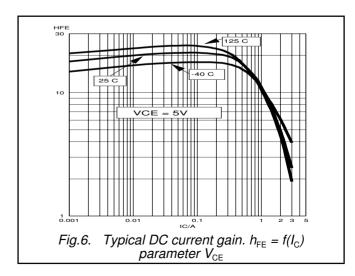






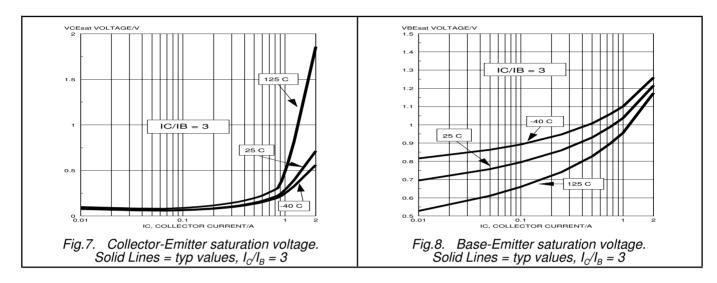




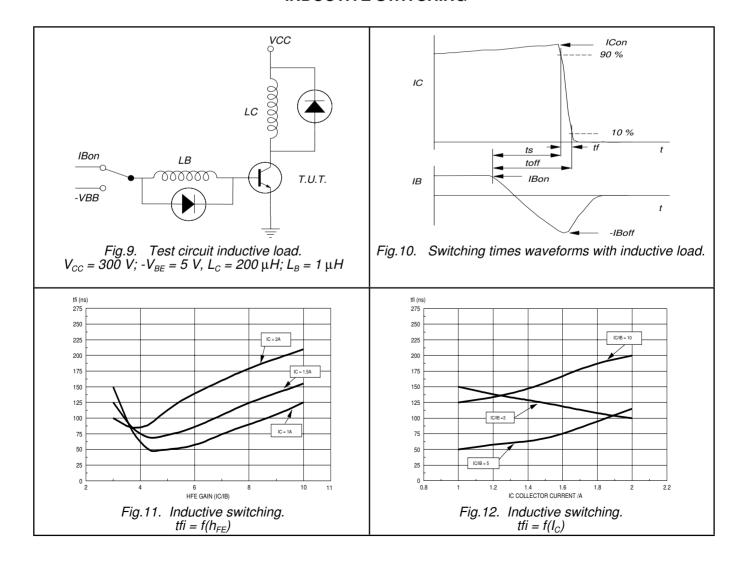


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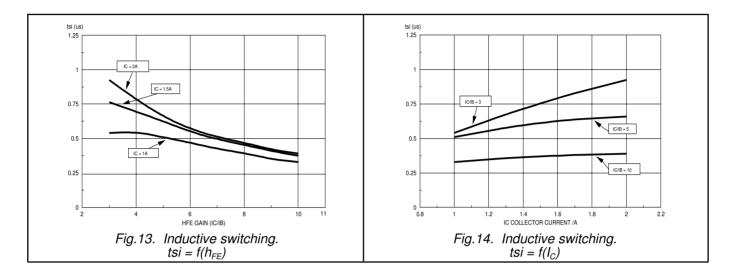


INDUCTIVE SWITCHING

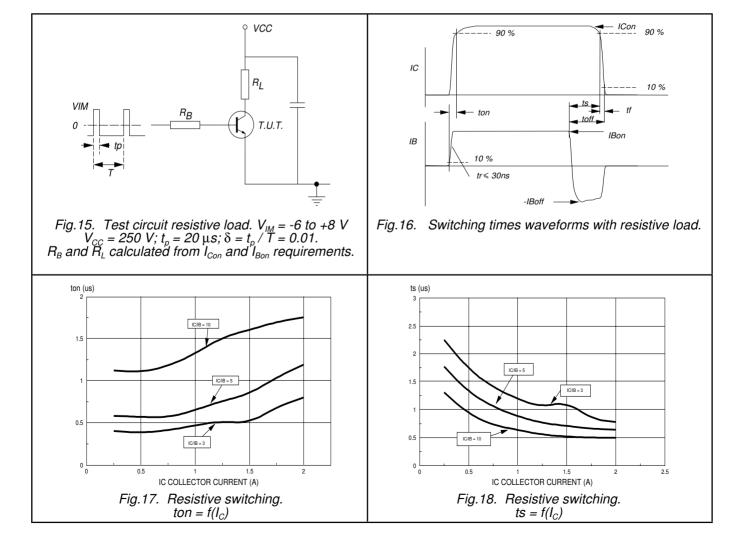


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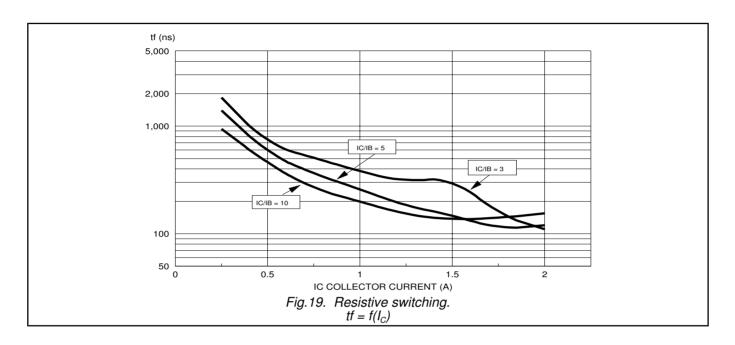


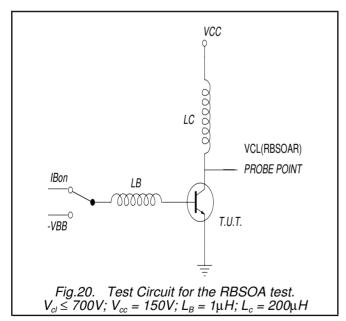
RESISTIVE SWITCHING

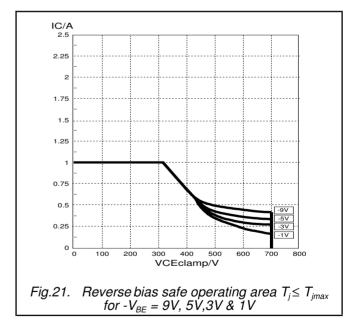


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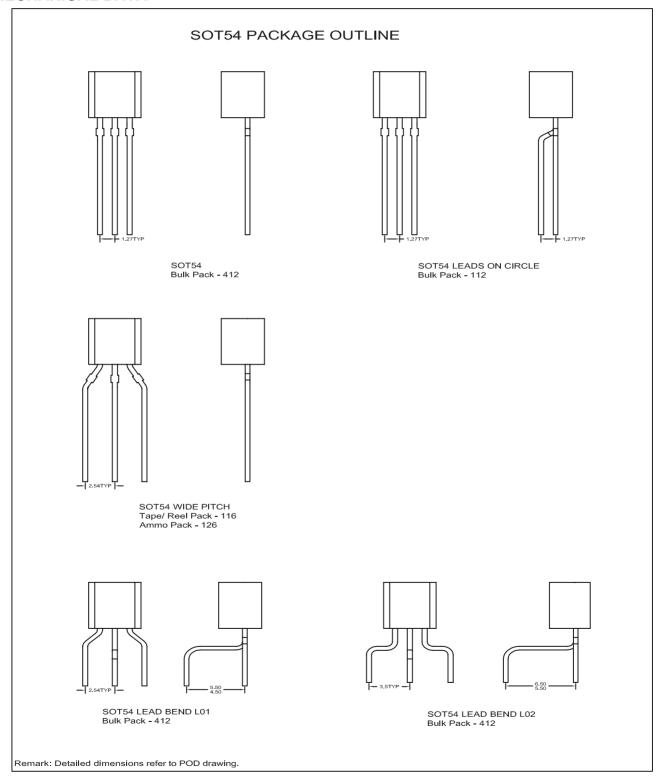




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MECHANICAL DATA



Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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